

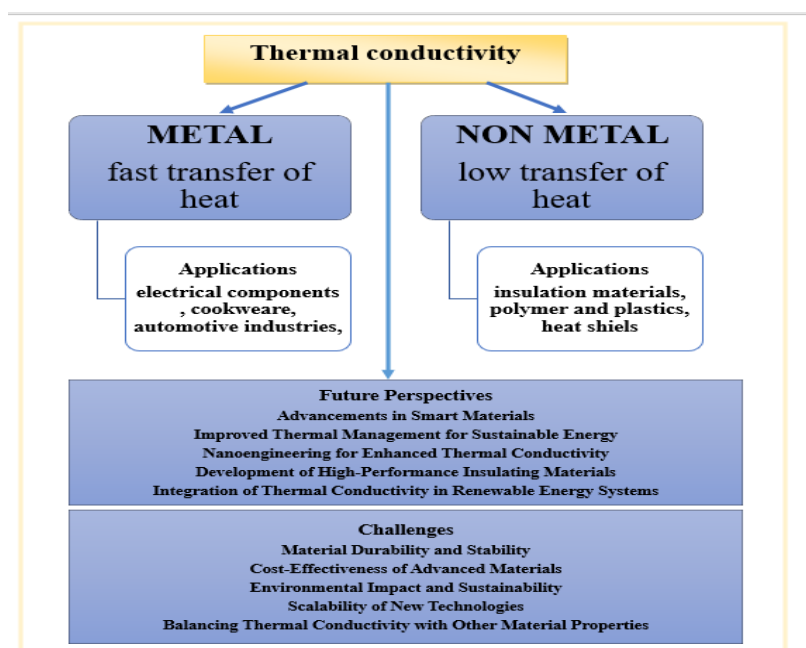
A Comprehensive Review On The Thermal Conductivity Of Materials: Mechanisms, Measurement Techniques, And Applications

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Abstract

With an emphasis on atomic structure, bonding, defect concentration, and microstructural features, this article investigates the variables affecting heat conductivity in metals, ceramics, polymers, and composites. The features of heat transfer, such as temperature, pressure, and material phase changes, are also examined. In metals, thermal conductivity is controlled by electron mobility, but in ceramics and polymers, it is determined by phonon interactions and molecular structure. Additionally covered in the review are experimental and computational approaches to measuring and forecasting thermal conductivity, such as transient or non-steady-state technologies like laser flash and transient hot-wire methods, as well as steady-state approaches like guarded hot plate and heat flow meter measurements. The benefits and drawbacks of each strategy, as well as how well they work with various materials, are also covered in the article. Heat conductivity has been improved using novel materials engineering approaches, including graphene, nanoparticles, nanowires, and composites containing phase-change components or high-conductivity fillers. Electronic heat sinks, thermal interface materials, high-performance computer systems, thermal barrier coatings, cryogenic storage, and energy-efficient architectural designs are some examples of the practical uses for materials with high and low heat conductivity. This research contributes significantly to **clean energy, sustainable infrastructure, energy-efficient buildings, and climate resilience**, aligning with global sustainability efforts.

Keywords: Thermal conductivity, metal, non-metal, graphene, nano-particles.



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1. Introduction

One essential characteristic of materials that has a big influence on the performance and design of thermal management systems in a variety of sectors is their capacity to conduct heat. Understanding and managing thermal conductivity is essential for maximizing effectiveness, safety, and longevity in a variety of applications, from commonplace items like kitchenware and building insulation to cutting-edge innovations in aircraft, microelectronics, and energy systems. The intrinsic attributes of a material, such as its atomic structure, bonding type, and microstructural features, determine its thermal conductivity (k). Metals are very effective at transporting thermal energy because heat is mostly carried by the movement of free electrons. [1-5] Non-metals, on the other hand, like ceramics and polymers, depend on phonon transport, or vibrations inside the atomic lattice, which frequently leaves them with reduced heat conductivity and makes them more suitable for insulation. Thermal conductivity can be created and customized using a variety of techniques, such as doping, nanostructuring, and the integration of composite materials, hence it is not a permanent attribute. In addition to a material's inherent conductivity, environmental variables including temperature, pressure, flaws, grain boundaries, and anisotropy can also affect how well a material performs in thermal management applications. [2,3] These variables can be tuned to optimize thermal performance by influencing how heat moves through a material. For instance, introducing controlled nanostructures can create channels that either enhance or restrict heat flow, depending on the intended application. Thermal conductivity is a basic property that has effects in many science and industrial fields. Heat management is very important in fields like electronics, aviation, automotive, and renewable energy, where performance, safety, and energy economy depend on controlling thermal transmission. New ideas, like phase-change materials, graphene-based nanocomposites, and thermal barrier layers that help heat escape and keep heat in, come from progress in nanotechnology, composite materials, and metamaterials. As the need for high-performance materials in harsh environments, renewable energy systems, and small technology grows, it becomes more and more important to know more about thermal conductivity. For scientists, engineers, and businesspeople working on next-generation thermal solutions, learning more about this topic helps them understand the basic processes, experimental methods, new trends, and useful applications. [4-7] Cahill, D. G. et al. [1] studied thermal conductivity in amorphous to know how amorphous nature of solid affect thermal conductivity, Slack, G. A. et al. [2] has examined the thermal conductivity in intrinsic material. Understanding how heat passes through various kinds of materials—such as metals, ceramics, polymers, and alloys—helps us to grasp this study on thermal conductivity. Improving thermal control in many various disciplines depends on this knowledge, which is quite crucial. This research significantly contributes to clean energy (SDG 7: Affordable and Clean Energy) by advancing materials that enhance energy efficiency through improved thermal management. It supports sustainable infrastructure (SDG 9: Industry, Innovation, and Infrastructure) by developing materials for energy-efficient buildings and climate resilience. The focus on energy-efficient technologies (SDG 12: Responsible Consumption and Production) helps reduce carbon emissions and aligns with global sustainability efforts aimed at reducing energy consumption and mitigating climate change (SDG 13: Climate Action).

2. New Developments and Trends in Thermal Management

New discoveries in material science have made it possible to better control how heat moves. Adding materials that transfer heat well, like carbon nanotubes (CNTs), graphene, and boron nitride, to composite structures can make them much better at getting rid of heat. This nanotechnology-based method has changed the field by allowing customized thermal control. People are also working on phase-change materials (PCMs), which can take, store, and release heat on demand. These materials are very useful for controlling temperature and storing energy. [3,8]

2.1 Basic Principles of Heat Conductivity

Heat passes through solids primarily by electron transport and phonon transport. Heat travels through metals largely because free electrons may move swiftly and effectively. Metals with high thermal conductivity, including copper, silver, and aluminum, have electrons that don't scatter much, allowing them to travel about readily and effectively transmit heat. Conversely, polymers and ceramics rely on phonon movement—that is, atomic wave movement across the lattice structure. Usually, metals conduct heat better than non-metals since heat travels through non-metals largely via phonons, vibrations of the atomic structure. It is more difficult for contaminants, flaws, and lattice motions to effectively transport heat since they most likely scatter phonons. This is why non-metals conduct heat less than metals do; electron mobility is a major component of heat transfer in metals. [1,2,4]

2.1.1. Defects and Lattice Structure: The way atoms are arranged in a material's lattice structure affects how well it conducts heat. When the crystal lattice is perfect, heat transmission works better because electrons and phonons can move with less resistance. Nevertheless, imperfections, grain boundaries, dislocations, and impurities are frequently present in real-world materials, all of which interfere with the efficient transport of heat. Grain boundaries and defects reduce total thermal conductivity by scattering electrons and phonons, which acts as a barrier to heat transport. For instance, because of higher phonon scattering at grain boundaries, polycrystalline materials often exhibit lower thermal conductivity than single-crystal structures. [6-8]

2.1.2. Temperature Dependence: Changes in phonon interactions are what cause materials' thermal conductivities to change with temperature. Metals' thermal conductivity often goes down as the temperature rises. This is because higher temperatures make electron-phonon scattering worse, which makes heat transfer less effective. Nonmetals, on the other hand, have a more complicated link with temperature. At low temperatures, there are fewer phonon scattering events, which makes it easier for heat to move. This makes thermal transmission better. But as temperatures rise, more interactions between phonons lead to more scattering and energy loss, which lowers thermal conductivity. It is very important to think about how materials will behave at different temperatures when making them for high-temperature uses like cryogenic systems or heat screens for spacecraft. [4-7]

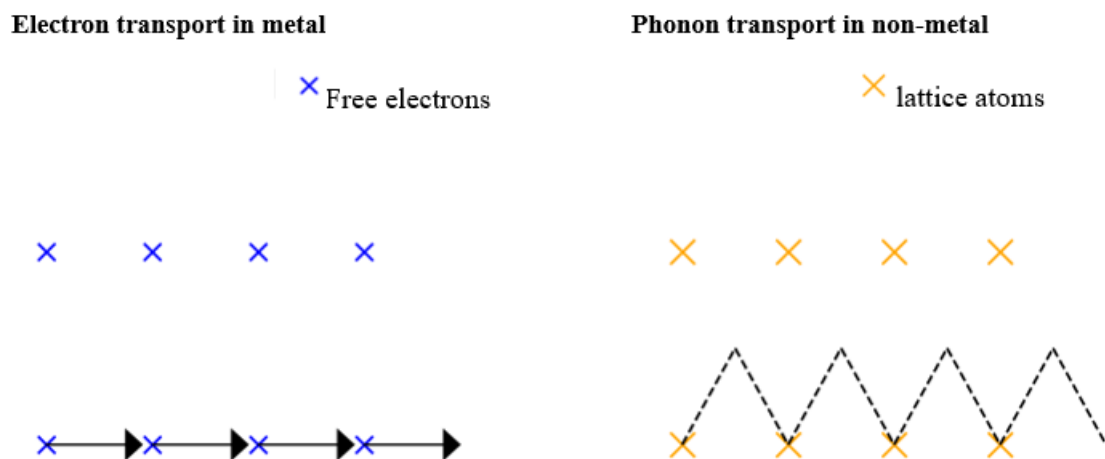


Figure 1. The mechanisms of heat transfer in various materials, such as the movement of electrons in metals and the transport of phonons in non-metals.

Because of their great mobility, free electrons in metals are primarily responsible for heat transfer. The blue circles in the figure represent electrons, which are thermal energy carriers that rapidly dissipate heat throughout the material. The arrows show which way electrons are moving, illustrating how well energy moves through metallic structures. Non-metals, on the other hand, rely on phonon transport, in which heat is transferred via atomic vibrations inside the lattice. Because of phonon

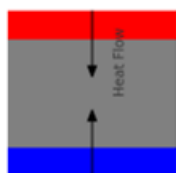
dispersion brought on by impurities, defects, and lattice vibrations, this mechanism—represented by orange circles that represent atoms—is typically less effective. The phonon propagation channel, which depicts the movement of heat through the material, is shown by the dashed wave-like lines. Non-metallic materials have lower thermal conductivity because phonon-based transport is more prone to interruptions than free electrons, which enable rapid conduction in metals. (Figure 1) [5-9]

3.Measurement Techniques

3.1. Steady-State Methods: Guarded hot plate, heat flow meter

Figure 2. shows the Guarded Hot Plate Method and the Heat Flow Meter Method are two examples of Steady-State Methods for measuring thermal conductivity that depend on creating a stable temperature differential prior to measurement. [8,9]

Guarded hot plate method



Heat flow meter method

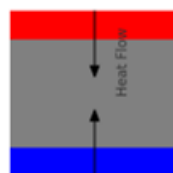
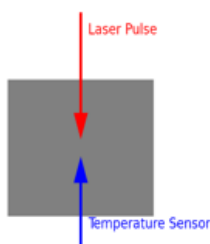


Figure 2. An illustration depicting thermal conductivity steady-state measurement techniques

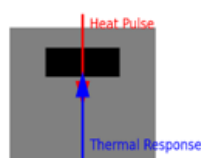
A cold plate is positioned underneath a heat source to maintain a temperature differential between two identical sample materials in the Guarded Hot Plate Method. The steady-state heat transfer equation can be used to accurately calculate thermal conductivity since heat moves through the sample uniformly. This technique works very well for insulating materials. In contrast, the Heat Flow Meter Method uses heat flow sensors to measure the heat flux through the material while the sample is sandwiched between a heated and a cold plate. Fourier's law is then used to calculate the thermal conductivity, which makes it appropriate for evaluating composites, polymers, and construction materials. Both techniques produce reliable results for materials having low thermal diffusivity since they maintain a steady heat flow during the test. [9-12]

3.2 Transient Methods

Laser flash method



Transient plane source method



Transient hot wire method

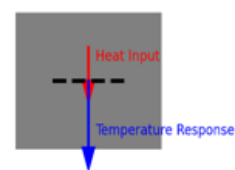


Figure 3. Laser flash analysis, transient planar source, transient hot wire technique

Laser Flash Analysis, Transient Plane Source, and Transient Hot Wire Methods are a few examples of transient thermal conductivity measurement techniques that offer rapid and precise thermal

characterization. By briefly applying a laser pulse to one side of the sample and using a temperature sensor on the other side to detect the increase in temperature, the Laser Flash Method is ideal for high-temperature materials such as metals and ceramics. Because it uses an embedded sensor heater to provide a heat pulse, the Transient Plane Source Method is suitable for solids, liquids, and composites. Next, the conductivity is determined by looking at the thermal reaction. The Transient Hot Wire Method, on the other hand, is frequently applied to fluids, molten materials, and polymers. It works by inserting a hot wire sensor within the sample, where an electrical current produces heat, and measuring the temperature response that results. These transient methods offer precise, quick, and non-destructive thermal conductivity measurements for a range of material kinds. [6-11]

4. Thermal Conductivity in Different Classes of Materials

Because free electrons flow efficiently in metals like copper, silver, and aluminum, they have high thermal conductivity, which makes them perfect for applications involving heat dissipation. The moderate to low thermal conductivity of ceramics, such as alumina and zirconia, on the other hand, makes them appropriate for insulating applications where thermal resistance or heat retention are needed. Although polymers have low thermal conductivity by nature, their heat transmission capacities can be enhanced for certain applications by engineering modifications, such as the addition of thermally conductive fillers. By providing enhanced thermal properties and combining lightweight structures with high heat conduction efficiency, composites and nanomaterials, such as carbon nanotubes, graphene, and advanced fillers, have transformed thermal management and are useful in contemporary electronics, aerospace, and energy applications. [2-9]

Table 1. Thermal conductivity of different materials. [2-9]

Material	Thermal Conductivity ($W/m.k$)
Copper	401
Silver	429
Aluminum	237
Steel	50
Glass	1.05
Concrete	1.75
Wood	0.12
Polystyrene	0.03

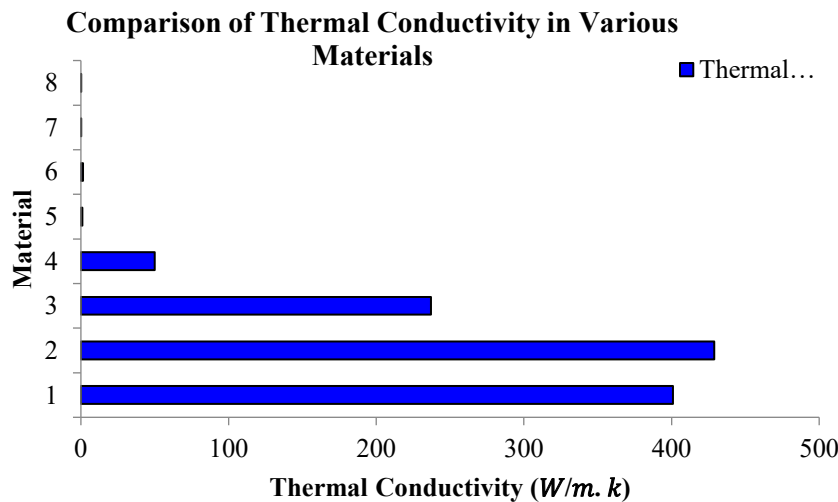


Figure 4. Comparison of Thermal Conductivity in Various Materials

The bar chart shows figure 4 how different materials transport heat efficiently by displaying their thermal conductivity. Because of their free electron mobility, metals like copper, silver, and

aluminum exhibit the maximum thermal conductivity, which makes them perfect for applications needing quick heat dissipation, such as heat exchangers and electronics. Steel is used in structural applications where thermal management is crucial but not the main concern because of its moderate conductivity. The building and packaging industries, on the other hand, find that non-metallic materials, such as glass, concrete, wood, and polystyrene, work well as thermal insulators because of their much lower heat conductivity. The right material can be chosen based on thermal performance criteria with the help of this comparison study. [7-13, 36-41]

5. Strategies to Enhance or Suppress Thermal Conductivity

In materials science, increasing or decreasing thermal conductivity is a crucial field of study with applications ranging from energy storage and electronics cooling to thermal management in aerospace and automobiles. A number of cutting-edge methods are used to modify the heat transfer characteristics of materials, such as composite engineering, material doping, and nano-structuring. In order to tune thermal conductivity, nano-structuring focusses on altering the microstructure at the nanoscale. This is mostly accomplished by decreasing the phonon mean free path, which can either increase or suppress heat transmission. The deliberate addition of various elements to a material in order to modify its phonic and electronic interactions and so regulate its thermal behavior is known as material doping. In the meanwhile, composite engineering maximizes heat dissipation for sophisticated thermal applications by incorporating high-conductivity materials into a host matrix. [8-14]

5.1 Nano-structuring Methodologies

By altering grain sizes, decreasing phonon dispersion, and improving surface interactions, nano-structuring is essential for managing heat transport. One important strategy is Nanomaterial-Enhanced Matrices, in which effective heat routes are created by embedding boron nitride nanostructures, graphene layers, and carbon nanotubes (CNTs) in a base material. By facilitating phonon transport, these nanostructures greatly increase heat conductivity. These techniques are frequently utilized to enhance heat dissipation and device performance in heat sinks, thermal interface materials, and next-generation electronic packaging. Phonon Scattering Control is another crucial nano-structuring technique that manipulates heat transfer by minimizing grain sizes and designing interfacial structures. While interfacial engineering maximizes phonon transmission at nanoparticle-matrix interfaces, reduced grain boundaries improve phonon mobility, which in turn leads to better heat conduction. These methods are frequently used in space-grade insulation systems, high-performance composite materials, and thermoelectric devices, where accurate heat flow management is essential for dependability and efficiency. [3-6]

5.2 Enhancing Thermal Conductivity using Composite Engineering

Adding high-conductivity nanoparticles to a host matrix through composite engineering is another efficient method of increasing thermal conductivity. One important strategy in this area is Nanofiller Integration, which significantly improves heat conduction by dispersing materials like graphene, carbon nanotubes, and boron nitride within polymer or ceramic matrices. Filler dispersion and nanomaterial alignment are key factors in this method's efficacy; a homogeneous dispersion guarantees steady thermal enhancement, and correctly aligned nanomaterials allow for directed heat flow, which maximizes performance. Managing heat in many different sectors, including aircraft, high-performance coatings, and thermal interface materials (TIMs), depends critically on customized composites. An integral component of composite engineering is designing heat flow routes. Aligned nanoparticles are actually more effective than randomly distributed fillers in transferring heat. Designed well, composites can manage heat better and outperform bulk materials. In fields like cooling electronics, energy storage systems, complex automotive parts, and insulation for the next generation of spacecraft where effective heat transmission is necessary to make things live longer and

operate better, these advances are quite vital. [4-9]

6. Industrial and Technological Applications of Thermal Conductivity

Managing heat in electronics, energy systems, aircraft, the automotive industry, and biomedicine are just a few of the numerous technological and industrial domains where thermal conductivity plays a crucial role. For critical systems to operate better, endure longer, and consume less energy, effective heat control is essential. Accurate regulation of heat transfer is crucial in many critical sectors, including electronic cooling systems, heat exchangers, and aeronautical materials. Reliable operation and protection from overheating of electronic devices necessitates efficient heat control. To cool the central processing unit (CPU) or graphics processing unit (GPU), heat is transferred from the CPU to a thermal interface material (TIM), and subsequently dissipated into the air using a heat sink. A cooling fan's ability to circulate air even further aids in the prevention of heat buildup. Vapor chamber technology and other modern cooling methods effectively disperse heat across a surface for high-performance systems by means of phase-change processes. A coolant is used in liquid cooling systems to transfer heat to a radiator for dissipation. Complex cooling solutions are essential for the optimal operation and extended lifespan of personal computers, gaming consoles, data centers, and high-performance computer systems. [11-16]

6.1 Energy Systems Heat Exchangers

Essential components in many different fields, heat exchangers help to effectively transfer thermal energy across fluids while preserving energy efficiency. Tube-and-shell heat exchangers are used extensively in thermostats, power plants, and oil refineries. Often composed of aluminum or copper, metal pipes help to transport heat while reducing fluid mixing in these exchangers. By contrast, many commercial and household uses including air conditioning, refrigeration, and food processing depend on plate heat exchangers. These setups layered metal plates to maximize surface area, hence optimizing heat transfer efficiency. Heat exchangers are essential for efficient management of heat in many different industrial uses, therefore improving performance and conserving energy. [13-15]

6.2 Materials for Aerospace and Thermal Control

For high temperatures in the aircraft sector, thermally resistant materials are absolutely vital. Multi-layer insulation (MLI) is used in spacecraft thermal protection to guard against rapid temperature fluctuations and lower heat loss in vacuum. High temperatures on satellites, space probes, and reentry vehicles call for this insulation both during launch and reentry. Ceramic material-based thermal barrier coatings (TBCs) increase fuel economy and resist high combustion temperatures. These coatings are essential for hypersonic aircraft, rocket nozzles, and jet engines to guarantee their performance and lifetime in very demanding environments. [12-16, 28-38]

7. Future Perspectives and Challenges in Thermal Conductivity Research

Increasingly, industries such as electronics, aerospace, energy, and advanced manufacturing require customized heat management solutions. This is causing the field of thermal conductivity research to expand rapidly. Recent advancements in nanotechnology, additive manufacturing, and hybrid composites have enabled scientists to modify the thermal properties of materials to accommodate various applications. By utilizing these technologies, it is possible to develop materials that exhibit superior thermal performance. This provides a variety of opportunities to enhance energy efficiency, thermal transfer, and insulation in a variety of settings. This ongoing investigation is crucial for addressing the challenges that high-performance systems present and for developing novel methods of thermal management. However, challenges related to large-scale production and the integration of emerging technologies persist as significant barriers. [13,15,10]

7.2 Development of Tailored Thermal Properties

The ability to create materials with tailored thermal conductivity is critical for applications ranging from high-performance heat dissipation in electronics to thermal insulation in aerospace. Advances in nano-structuring and composite engineering have enabled the development of directed or adjustable heat transfer materials, which improve heat-spreading efficiency. Phase-change materials (PCMs), thermoelectric materials, and polymer-based nanocomposites are being developed to meet industry-specific heat management requirements while providing excellent thermal performance in harsh situations. These developments pave the way for energy-saving systems, such as self-regulating thermal materials for smart devices and passive cooling technologies for space applications. [31-41]

7.3 Challenges of Large-Scale Fabrication and Integration

While lab-scale demonstrations of high-performance thermal materials have showed great promise, scaling these technologies to industrial manufacturing remains a substantial barrier. Cost-effectiveness, material stability, and compatibility with existing production processes are critical challenges that must be addressed before widespread adoption can occur. High-thermal-conductivity nanomaterials such as graphene, boron nitride, and carbon nanotubes are frequently difficult to integrate into commercial products due to dispersion concerns, interfacial resistance, and manufacturing challenges. Furthermore, establishing scalable synthesis methods that maintain these materials' excellent thermal characteristics is a major research priority, as the economic viability of such advanced materials is dependent on overcoming these constraints. [16-18, 32-40]

7.4 Emerging technologies: quantum materials and metamaterials

Quantum materials and metamaterials represent new frontiers in thermal conductivity research, providing novel heat transfer mechanisms that have the potential to revolutionize thermal management. Quantum materials, such as topological insulators and low-dimensional materials, have new thermal properties that could lead to efficient energy harvesting and ultra-high thermal transport systems. Meanwhile, metamaterials designed with artificial microstructures enable anisotropic heat conduction, thermal cloaking, and ultra-efficient insulation, paving the way for thermal camouflage and next-generation insulation technologies. Furthermore, research in phonon engineering and thermal rectification is allowing for the development of directional heat flow materials, which will lead to advancements in thermal transistors, space-grade insulators, and advanced heat regulation for severe conditions. [25-42]

8. Conclusion

Thermal conductivity is a crucial physical property in various fields, including microelectronics, energy systems, aerospace, and biomedical applications. Effective heat management is essential for device performance, safety, and longevity. As modern technologies advance, efficient thermal management becomes increasingly important, as improper heat dissipation can lead to device failure, decreased energy efficiency, and compromised reliability. In microelectronics, managing heat effectively has become a pressing challenge due to the increasing miniaturization and power density of devices. Advanced materials with high thermal conductivity, such as diamond-like carbon films and graphene-based materials, offer exceptional heat dissipation properties. In contrast, low thermal conductivity materials, like aerogels, foams, and vacuum-insulated panels, are used to improve energy efficiency and reduce heat loss. Recent advances in material design and nanotechnology have revolutionized the development of new materials with tailored thermal properties. Nanostructured materials can be engineered to alter heat transport properties, allowing them to conduct heat efficiently or provide excellent insulation. Metamaterials, designed to control heat flow in novel ways, are also being explored for thermal management. Quantum heat transport is being explored to better understand heat transfer at the microscopic level, leading to breakthroughs in thermoelectric devices and heat shielding for next-generation space exploration vehicles. Computational modeling and

machine learning are becoming invaluable tools in accelerating the discovery and design of new materials with tailored thermal properties.

The integration of multidisciplinary approaches is leading to more sophisticated and effective strategies for thermal management, with the future of thermal management technologies poised for transformative advancements in industries like aerospace, automotive, electronics, and healthcare.

CRedit authorship contribution statement

Jaza penned the original paper to contribute to the study's concept, methodology, formal analysis, and research. Ansari Novman Nabeel and Ansari Ammara Firdaus did a lot of work on the manuscript, including writing, reviewing, and editing. Data visualization and overall investigational has been done. she supervised the research, provided feedback on its progress, produced visual materials, examined and revised the text, and made numerous significant contributions to the study.

Declaration of Competing Interest

In spite of the fact that the authors admitted to have potentially conflicting personal and financial interests, the findings of the study would not have been altered by their work anyway.

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Reference

1. Cahill, D. G., Pohl, R. O. (1987). Thermal conductivity of amorphous solids above the plateau. *Physical Review B*, 35(8), 4067–4073.
2. Slack, G. A., Tanzilli, R. A., Pohl, R. O., Vandersande, J. W. (1987). The intrinsic thermal conductivity of AlN. *Journal of Physics and Chemistry of Solids*, 48(7), 641–647.
3. Swartz, E. T., Pohl, R. O. (1989). Thermal boundary resistance. *Reviews of Modern Physics*, 61(3), 605–668.
4. Cahill, D. G., Watson, S. K., Pohl, R. O. (1992). Lower limit to the thermal conductivity of disordered crystals. *Physical Review B*, 46(10), 6131–6140.
5. Olson, J. R., Pohl, R. O., Vandersande, J. W., Zoltan, A., Anthony, T. R. (1993). Thermal conductivity of diamond between 170 and 1200 K and the isotope effect. *Physical Review B*, 47(22), 14850–14856.
6. Wei, L., Kuo, P. K., Thomas, R. L., Anthony, T. R., Banholzer, W. F. (1993). Thermal conductivity of isotopically modified single crystal diamond. *Physical Review Letters*, 70(24), 3764–3767.
7. Balandin, A. A., Ghosh, S., Bao, W., Calizo, I., Teweldebrhan, D., Miao, F., Lau, C. N. (2008). Superior thermal conductivity of single-layer graphene. *Nano Letters*, 8(3), 902–907.
8. Ghosh, S., Bao, W., Nika, D. L., Subrina, S., Pokatilov, E. P., Lau, C. N., Balandin, A. A. (2010). Dimensional crossover of thermal transport in few-layer graphene. *Nature Materials*, 9(7), 555–558.
9. Balandin, A. A. (2011). Thermal properties of graphene and nanostructured carbon materials. *Nature Materials*, 10(8), 569–581.
10. Nika, D. L., Balandin, A. A. (2017). Phonons and thermal transport in graphene and graphene-based materials. *Reports on Progress in Physics*, 80(3), 036502.
11. Savija, I., Culham, J. R., Yovanovich, M. M., and Marotta, E. E., (2003) Review of Thermal Conductance Models for Joints Incorporating Enhancement Materials. *J. Thermophysics Heat Transfer*, 17(1), 43–52.
12. Tritt, T. M., and Weston, D., (2004). Measurement Techniques and Considerations for Determining Thermal Conductivity of Bulk Materials. *Thermal Conductivity*, T. M. Tritt, ed.,

Springer, New York, 187–203.

13. Hamilton, R. L., and Crosser, O. K., (1962). Thermal Conductivity of Heterogeneous Two-Component Systems,” *Ind. Eng. Chem. Fundam.*, 1(3), 187–191.
14. Zeller, R. C., and Pohl, R. O., (1971). Thermal Conductivity and Specific Heat of Noncrystalline Solids. *Phys. Rev. B*, 4(6), 2029–2041.
15. Cooper, M. G., Mikic, B. B., and Yovanovich, M. M., (1969). Thermal Contact Conductance. *Int. J. Heat Mass Transfer*, 12(3), 279–300.
16. Kargar, F., Debnath, B., Kakko, J.-P., Säynätjoki, A., Lipsanen, H., Nika, D. L., Lake, R. K., Balandin, A. A. (2016). Direct observation of confined acoustic phonon polarization branches in free-standing semiconductor nanowires. *Nature Communications*, 7, 13400.
17. Balandin, A. A. (2020). Phononics of graphene and related materials. *ACS Nano*, 14(5), 5170–5178.
18. Rumyantsev, S., Liu, G., Shur, M. S., Potyailo, R. A., Balandin, A. A. (2012). Selective gas sensing with a single pristine graphene transistor. *Nano Letters*, 12(5), 2294–2298.
19. Walker, C. T., Pohl, R. O. (1961). Phonon Scattering by Point Defects. *Physical Review*, 120(3), 745–755.
20. Narayanamurti, V., Pohl, R. O. (1970). Tunneling States of Defects in Solids. *Reviews of Modern Physics*, 42(1), 201–236.
21. Cahill, D. G., Ford, W. K., Goodson, K. E., Mahan, G. D., Majumdar, A., Maris, H. J., Merlin, R., & Phillpot, S. R. (2003). Nanoscale thermal transport. *Journal of Applied Physics*, 93(2), 793–818.
22. Pop, E., Varshney, V., & Roy, A. K. (2012). Thermal properties of graphene: Fundamentals and applications. *MRS Bulletin*, 37(12), 1273–1281.
23. Goyal, V., & Balandin, A. A. (2012). Thermal properties of the hybrid graphene-metal nano-micro-composites: Applications in thermal interface materials. *Applied Physics Letters*, 100(7), 073113.
24. Zebarjadi, M., Esfarjani, K., Dresselhaus, M. S., Ren, Z. F., Chen, G. (2012). Perspectives on thermos-electrics: From fundamentals to device applications. *Energy & Environmental Science*, 5(1), 5147–5162.
25. Minnich, A. J., Johnson, J. A., Schmidt, A. J., Esfarjani, K., Dresselhaus, M. S., Nelson, K. A., Chen, G. (2011). Thermal conductivity spectroscopy technique to measure phonon mean free paths. *Physical Review Letters*, 107(9), 095901.
26. Zhang, X., Zhang, H. (2017). Thermal conductivity of nanostructured materials. *Journal of Physics: Condensed Matter*, 29(4), 043001.
27. Giri, A., Hopkins, P. E. (2014). A review of experimental and computational advances in thermal boundary conductance and nanoscale thermal transport across solid interfaces. *Advances in Functional Materials*, 24(38), 5877–5889.
28. Cahill, D. G., Braun, P. V., Chen, G., Clarke, D. R., Fan, S., Goodson, K. E., Keblinski, P., King, W. P., Mahan, G. D., Majumdar, A., Maris, H. J., Phillpot, S. R., Pop, E., Shi, L. (2014). Nanoscale thermal transport. II. 2003–2012. *Applied Physics Reviews*, 1(1), 011305.
29. Zhang, T., Luo, T., Chen, G. (2013). Heat conduction mechanisms in nanofluids and suspensions. *Reviews of Modern Physics*, 85(3), 1085–1122.
30. Shen, S., Henry, A., Tong, J., Zheng, R., Chen, G. (2010). Polyethylene nanofibres with very high thermal conductivities. *Nature Nanotechnology*, 5(4), 251–255.
31. Zhang, X., Sun, D., Li, Y., Lee, G.-H., Cui, X., Chenet, D., You, Y., Heinz, T. F., Hone, J. C. (2015). Measurement of lateral and interfacial thermal conductivity of single- and bilayer MoS₂ and MoSe₂ using refined optothermal Raman technique. *ACS Applied Materials & Interfaces*, 7(46), 25923–25929.
32. Li, D., Yang, R. (2012). Thermal conductivity of nanostructured materials. *Journal of Physics D: Applied Physics*, 45(19), 195303.

33. Zhang, X., Zhang, H. (2016). Thermal transport in two-dimensional materials. *Journal of Physics: Condensed Matter*, 28(48), 483001.
34. Luo, T., Chen, G. (2013). Nanoscale heat transfer—From computation to experiment. *Physics Today*, 66(7), 44–49.
35. Zhang, X., Li, D. (2010). Thermal conductivity of nanostructured materials. *Journal of Physics: Condensed Matter*, 22(43), 434206.
36. Ghosh, S., Calizo, I., Teweldebrhan, D., Pokatilov, E. P., Nika, D. L., Balandin, A. A., Bao, W., Miao, F., Lau, C. N. (2008). Extremely high thermal conductivity of graphene: Prospects for thermal management applications in nanoelectronic circuits. *Applied Physics Letters*, 92(15), 151911.
37. Zhang, X., & Zhang, H. (2017). Thermal conductivity of two-dimensional materials. *Journal of Physics: Condensed Matter*, 29(4), 043001.
38. Liu, W., Yang, N. (2019). Thermal transport in single-layer transition metal dichalcogenides. *Physical Chemistry Chemical Physics*, 21(25), 13219–13235.
39. Zhang, X., & Zhang, H. (2018). Phonon transport in two-dimensional materials: A review. *Annalen der Physik*, 530(1), 1700286.
40. Zhao, D., Qian, X., Gu, X., Jajja, S. A., Yang, R. (2016). Measurement techniques for thermal conductivity and interfacial thermal conductance of bulk and thin film materials. *Journal of Electronic Packaging*, 138(4), 040802.
41. Xu, X., Chen, J., Zhou, J., Li, B. (2018). Thermal conductivity of polymers and their nanocomposites. *Advanced Materials*, 30(17), 1705544.
42. Yan, X., Wang, B., Hai, Y., Kripalani, D. R., Ke, Q., Cai, Y. (2022). Phonon anharmonicity and thermal conductivity of two-dimensional van der Waals materials: A review. *Nanomaterials*, 12(20), 3571.